# Fee schedule for CEDT Facilities Sept. 2019 (Applies to Canadian grant funded research) Rates are subject to review every 6 months

#### Clean Rooms:

JHE-A306: There are two adjacent clean rooms;

a) The PL side is for photolithography. It contains a wet bench, spinner, and MJB3 mask aligner, UV-ozone source, holography exposure, optical microscope with digital camera, alpha step profilometer, plasma asher, critical point dryer, oven (20–150°C), programmable furnace (20–1000°C) and a stress measurement tool.

b) The RIE side is for deposition and dry etch. It contains ECR RIE (for III-V materials), SiON RIE (H<sub>2</sub>, CF<sub>4</sub> and O<sub>2</sub> gases are available), SiON PECVD, e-beam metallization system, and a wet bench.

Access to the PL side of the clean rooms for photolithography is offered by scheduled sessions. A typical day contains 5 two-hour sessions. An individual may reserve at most 3 consecutive sessions in a day, or two non-consecutive sessions in a day, providing that the reservation includes either the first or last session of the day. The charge rate is \$30/hr per person for the duration of the session. If two or more people have agreed to shared use of this room for photolithography, each person will be charged at \$30/hr for the duration of the session. A newcomer may accompany a trained person for the purpose of observation without additional charge, provided they have taken all the required safety training and notified our staff.

This charge rate does not apply to the unscheduled use (i.e. when photolithography is not being done) of individual equipment in this room, namely the optical microscope, alpha step profilometer, plasma asher, stress tool, wet bench, UV-ozone, furnace/oven. See rate schedule below for individual charges.

If the PL side is booked, the priority on all tools in that room is held by the person(s) with the booking.

The fees described above do not include training of students by CEDT staff. The charge for initial training on these CEDT facilities is \$35/hr. Only one person at a time will be trained.

Access to the apparatus on the RIE side of the clean rooms and individual processes on the PL side is offered on a fee basis, according to the following fee schedule:

Facility – PL side	Fee	Unit	Notes	
Photolithography	\$30.00	per hour	In 2 hour sessions	
Wet bench	\$25.00	per hour		
Spinner only	\$25.00	per hour	Wet bench rate	
Holography exposure	\$30.00	per hour		
Stress tool	\$10.00	per hour	30 minutes minimum	
Optical microscope, w. camera	\$10.00	per hour	30 minutes minimum	
Alpha step profilometer	\$10.00	per hour	30 minutes minimum	
Critical point dryer	\$15.00	per run		
UV-ozone	\$10.00	per run		
Furnace/oven	\$10.00	per run		
Plasma asher	\$5.00	per run		
SEM	\$20.00	per hour		
Facility – RIE side	Fee	Unit	Notes	
Wet bench	\$25.00	per hour		
e-beam evaporator	\$90.00	per run	extra charge for Au/Pt	
Technic PE-CVD, for SiON growth	\$50.00	per run		
Technics RIE, for SiON etching	\$40.00	per run		
ECR-RIE (III-V)	\$90.00	per run		

Note: Evaporation of Au or Pt will be charged an additional fee at market rates. Current rates are \$5 per 20 nm of Au and \$8 per 20 nm of Pt.

Standard chemicals are included in the prices above – including standard photoresists, developers, solvents, bases and acids. Spin-on dopants, spin-on glasses and other non-standard materials must be provided by the user or ordered by our staff and are subject to compliance with our safety procedures and explicit authorization by our staff.

#### Clean Room Addition, JHE-A307:

Direct Write Laser Lithography: \$40/hr

Oxford DRIE: \$70 set-up fee + \$35/hour

Wafer Bonder: \$30 set-up fee + \$5/hour

Kurt Lesker PVD: \$50 set-up fee + \$30/hour + cost of material, i.e. sputter targets, precious metal surcharge etc.

#### **Characterization and Processing:**

**JHE-A305:** locally exhausted laminar flow benches, DI water and chemicals, polishing tools.

JHE-318: Variable angle spectroscopic ellipsometry.

**TAB-110 Annex 1:** LT Hall probe, grating PL tool, X-ray QC1, RIE ( $N_2$ , Ar, SF<sub>6</sub>, C<sub>4</sub>F<sub>8</sub> and O<sub>2</sub> gases are available), and a scriber.

**TAB-205 Annex 2:** RTAs (III-V and Si), tube furnaces, and a sample preparation wet bench.

Location	Facility	Fee	Unit	Notes
JHE A305	Polishing tools	\$25.00	per hour	
JHE A305	HF/DI water station	\$25.00	per hour	
TAB Annex	RIE (fast etch tool)	\$50.00	per hour	
TAB Annex	x-ray	\$20.00	per hour	
TAB Annex	RTA (III-V)	\$15.00	per hour	

ABB-B147 (CCEM): e-beam lithography.

The charge for initial training on these CEDT facilities is \$35/hr. Only one person at a time will be trained.

Please contact CEDT staff for fees for accessing individual pieces of characterization equipment not listed here.

## Materials Growth Facilities:

## **TAB 1:** MBE, Ion Implanter, PECVD

a) MBE – typical rates are 150/growth hour + substrate costs + calibration costs. The calibration costs will be shared by growths that require the same calibration.

b) Ion implantation – typical rates are 130/implant hour + a 300 set-up fee. The set-up fee will be shared by implants that require the same set-up.

c) PECVD – please contact Dr. Peter Mascher for information regarding growths.

## Additional Facilities:

**JHE-318:** dc and RF sputtering system. Two targets can be loaded into the system at the same time and sputtered sequentially by dc or RF guns. There is a \$30 set-up fee + a 30/hour charge. Sputtering from the CEDT Au or Pt targets will be charged an additional fee at market rates. No Pt target is available at this time. Current metal surcharge rates are \$5 per 20 nm of Au and \$8 per 20 nm of Pt.

**JHE-318:** the wire and wedge bonders can only be operated by CEDT staff at this time, at a fee of \$80/hour, with a 15 minute minimum charge.

**TAB Annex 2:** the dicing saw can only be operated by CEDT staff at this time, at a fee of \$80/hour, with a 30-minute minimum charge.

## CEDT staff time:

The CEDT staff members are available for additional support at the following rates:

- a) Additional training sessions: \$50/hour, 30 minute minimum
- b) Project consultation and/or process development: \$50/hour, 30 minute minimum
- c) "Contract work" on a short- or medium-term project: \$70/hour.

These staff rates do not include other charges for facility use as listed above.